

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>TINGFANG JI</td> <td>11/07/2013</td> </tr> <tr> <td>PETER GAAL</td> <td>11/07/2013</td> </tr> <tr> <td>HAO XU</td> <td>11/07/2013</td> </tr> <tr> <td>WANSI CHEN</td> <td>11/07/2013</td> </tr> </tbody> </table>		Name	Execution Date	TINGFANG JI	11/07/2013	PETER GAAL	11/07/2013	HAO XU	11/07/2013	WANSI CHEN	11/07/2013
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>QUALCOMM INCORPORATED</td> </tr> <tr> <td>Street Address:</td> <td>5775 MOREHOUSE DRIVE</td> </tr> <tr> <td>City:</td> <td>SAN DIEGO</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>92121-1714</td> </tr> </table>		Name:	QUALCOMM INCORPORATED	Street Address:	5775 MOREHOUSE DRIVE	City:	SAN DIEGO	State/Country:	CALIFORNIA	Postal Code:	92121-1714
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
<p>Fax Number: (713)623-4846</p> <p>Phone: (713) 623-4844</p> <p>Email: mmiles@pattersonsheridan.com, PSDocketing@pattersonsheridan.com</p> <p><i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i></p> <p>Correspondent Name: PATTERSON & SHERIDAN, LLP</p> <p>Address Line 1: 3040 POST OAK BLVD.</p> <p>Address Line 2: SUITE 1500</p> <p>Address Line 4: HOUSTON, TEXAS 77056</p>											
ATTORNEY DOCKET NUMBER:	130374US										
NAME OF SUBMITTER:	RANDOL W. READ										

Signature:	/Randol W. READ/
Date:	11/14/2013
Total Attachments: 3 source=130374_Assignment#page1.tif source=130374_Assignment#page2.tif source=130374_Assignment#page3.tif	

ASSIGNMENT

WHEREAS, WE,

1. **Tingfang Ji**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of **San Diego, CA**;
2. **Peter Gaal**, a citizen of the **United States of America**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of **San Diego, CA**;
3. **Hao Xu**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of **San Diego, CA**; and
4. **Wanshi Chen**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of **San Diego, CA**;

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **UPLINK COVERAGE ENHANCEMENTS** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said **INVENTIONS**, including all patent applications therefor that may have been filed or may be filed hereafter for said **INVENTIONS** in the United States, including but not limited to U.S. Application No. **14/060,924**, filed **October 23, 2013**, Qualcomm Reference No. **130374**, and all provisional applications relating thereto, together with U.S. Provisional Application No. **61/720,361**, filed **October 30, 2012**, Qualcomm Reference No. **130374P1**, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, all rights of priority under International

Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

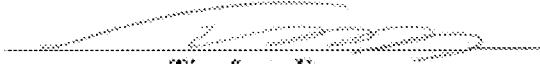
AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 11/07/13
LOCATION DATE

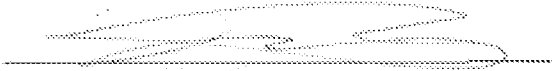

Tingfang Ji


Done at San Diego, on 11/07/13
LOCATION DATE


Peter Gaal

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 11/7/2013 
LOCATION DATE Hao Xu

Done at San Diego, on November 7, 2013 
LOCATION DATE Wanshi Chen